# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

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### **GENERAL PURPOSE AMPLIFIER**

RoHS Compliant & Pb-Free Product Package Style: Micro-X Ceramic

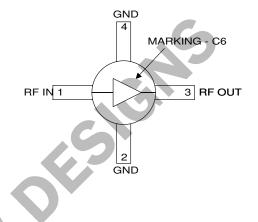
### Features

- DC to 3000 MHz Operation
- Internally matched Input and Output
- 22dB Small Signal Gain
- 3.0dB Noise Figure
- 10 mW Linear Output Power
- Single Positive Power Supply

### **Applications**

- Broadband, Low Noise Gain Blocks
- IF or RF Buffer Amplifiers
- Driver Stage for Power Amplifiers
- Final PA for Low Power Applications
- High Reliability Applications
- Broadband Test Equipment





Functional Block Diagram

### **Product Description**

The RF2046 is a general purpose, low cost RF amplifier IC. The device is manufactured on an advanced Gallium Arsenide Heterojunction Bipolar Transistor (HBT) process, and has been designed for use as an easily-cascadable 50 $\Omega$  gain block. Applications include IF and RF amplification in wireless voice and data communication products operating in frequency bands up to 3000MHz. The device is self-contained with 50 $\Omega$  input and output impedances and requires only two external DC biasing elements to operate as specified. With a goal of enhanced reliability, the extremely small Micro-X ceramic package offers significantly lower thermal resistance than similar size plastic packages.

### **Ordering Information**

RF2046General Purpose AmplifierRF2046PCBA-41XFully Assembled Evaluation Board

### Optimum Technology Matching® Applied

🗹 GaAs HBT	□ SiGe BiCMOS	🗌 GaAs pHEMT	🗌 GaN HEMT
GaAs MESFET	🗌 Si BiCMOS	Si CMOS	
🗌 InGaP HBT	SiGe HBT	🗌 Si BJT	

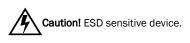
RF MICRO DEVICES®, RFMD®, Optimum Technology Matching®, Enabling Wireless Connectivity<sup>M</sup>, PowerStar®, POLARIS<sup>M</sup> TOTAL RADIO<sup>M</sup> and UltimateBlue<sup>M</sup> are trademarks of RFMD, LLC. BLUETOOTH is a trade mark owned by Bluetooth SIG, Inc., U.S.A. and licensed for use by RFMD. All other trade names, trademarks and registered trademarks are the property of their respective owners. @2006. RF Micro Devices. Inc.

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### **Absolute Maximum Ratings**

Parameter	Rating	Unit
Input RF Power	+13	dBm
Operating Ambient Temperature	-40 to +85	°C
Storage Temperature	-60 to +150	°C



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RoHS status based on EUDirective 2002/95/EC (at time of this document revision).

Devenuetar	Specification		11			
Parameter	Min.	Typ. Max.		Unit	Condition	
Overall					T=25 °C, V <sub>D</sub> =3.5V, I <sub>CC</sub> =35mA	
Frequency Range		DC to 3000		MHz		
Gain		22.7		dB	Freq=100MHz	
		22.1		dB	Freq=1000MHz	
	18	21.0		dB	Freq=2000MHz	
		19.2		dB	Freq=3000MHz	
Gain Flatness		±0.9		dB	100 MHz to 2000 MHz	
Noise Figure		2.7		dB	Freq=2000MHz	
Input VSWR		<2.0:1			In a 50 $\Omega$ system, DC to 3000 MHz	
Output VSWR		<1.9:1			In a 50 $\Omega$ system, DC to 3000 MHz	
Output IP <sub>3</sub>		+23.5		dBm	Freq=2000MHz±100kHz, P <sub>TONE</sub> =-18dBm	
Output P <sub>1dB</sub>		+10.7		dBm	Freq=2000MHz	
Reverse Isolation		22.8		dB	Freq=2000MHz	
Thermal					I <sub>CC</sub> =35mA, P <sub>DISS</sub> =116mW (See Note 1.)	
Theta <sub>JC</sub>		275		°C/W		
Maximum Measured Junction Temperature at DC Bias Condi- tions	0	117		°C		
Mean Time To Failure (MTTF)		280,000		years	T <sub>AMB</sub> =+85 °C	
Power Supply					With $22\Omega$ bias resistor, T=+25°C	
Device Operating Voltage	3.0	3.5	4.0	V	At pin 3 with I <sub>CC</sub> =35mA	
	3.6	4.3	4.6	V	At evaluation board connector, I <sub>CC</sub> =35mA	
Operating Current			35	mA	See Note 2.	

NOTES:

Note 1: The RF2046 must be operated at or below 35 mA in order to achieve the thermal performance stated above. Operating at 35 mA will ensure the best possible combination of reliability and electrical performance.

Note 2: Because of process variations from part to part, the current resulting from a fixed bias voltage will vary. As a result, caution should be used in designing fixed voltage bias circuits to ensure the worst case bias current does not exceed 35 mA over all intended operating conditions.

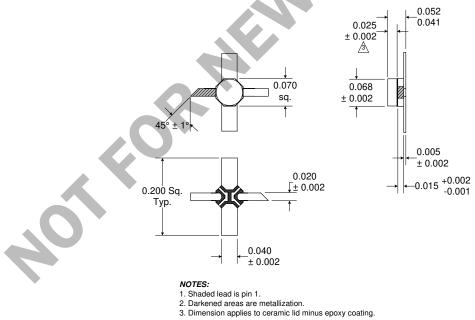


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# **RF2046**

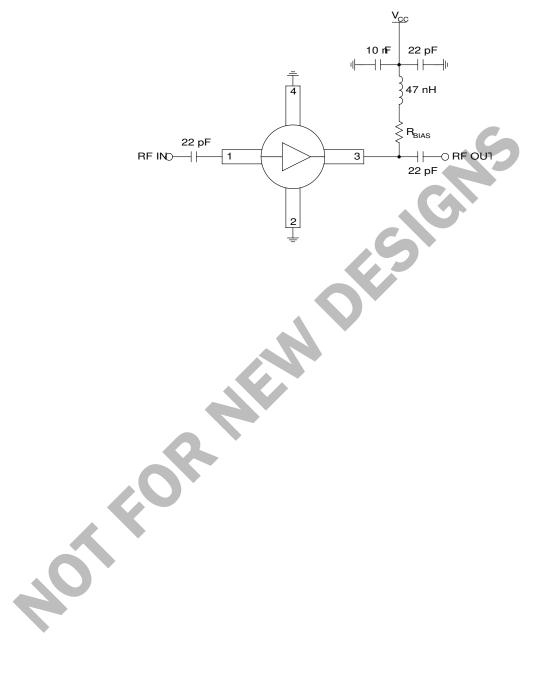
Pin	Function	Description	Interface Schematic
1	RF IN	RF input pin. This pin is NOT internally DC-blocked. A DC-blocking capacitor, suitable for the frequency of operation, should be used in most applications. DC-coupling of the input is not allowed, because this will override the internal feedback loop and cause temperature instability.	
2	GND	Ground connection. For best performance, keep traces physically short and connect immediately to ground plane.	
3	RF OUT	RF output and bias pin. Biasing is accomplished with an external series resistor and choke inductor to V <sub>CC</sub> . The resistor is selected to set the DC current into this pin to a desired level. The resistor value is determined by the following equation: $R = \frac{(V_{SUPPLY} - V_{DEVICE})}{I_{CC}}$ Care should also be taken in the resistor selection to <b>ensure that the current into the part never exceeds 35 mA over the planned operating temperature</b> . This means that a resistor between the supply and this pin is always required, even if a supply near 3.5V is available, to provide DC feedback to prevent thermal runaway. Because DC is present on this pin, a DC-blocking capacitor, suitable for the frequency of operation, should be used in most applications. The supply side of the bias network should also be well bypassed.	
4	GND	Same as pin 2.	

### Package Drawing





### **Application Schematic**

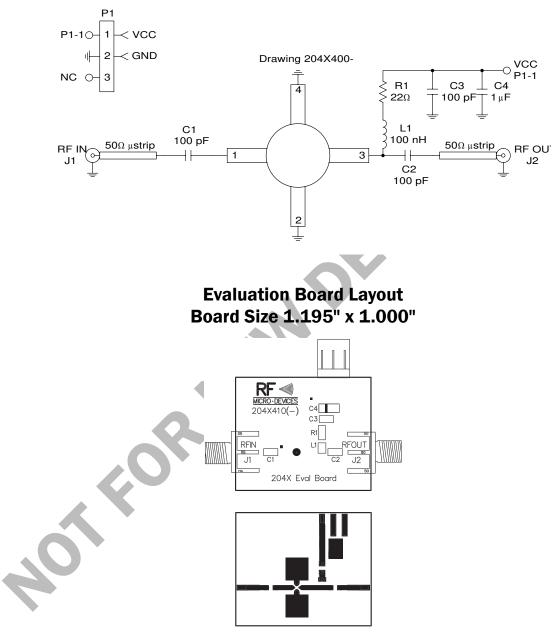






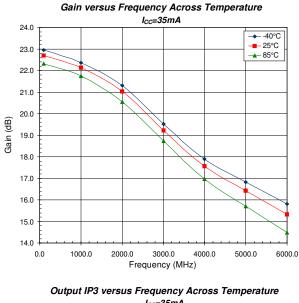
### **Evaluation Board Schematic**

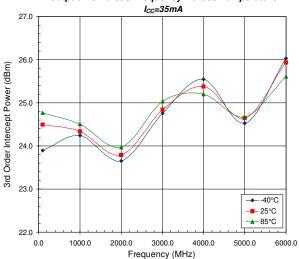
(Download Bill of Materials from www.rfmd.com.)

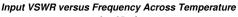


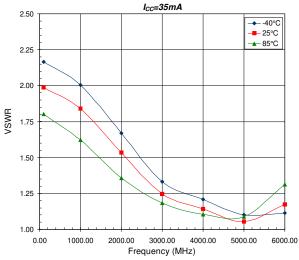


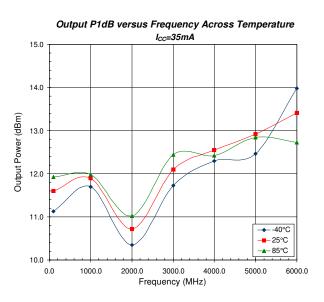




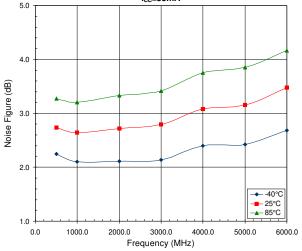




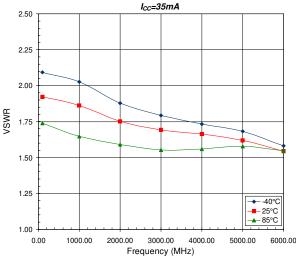




Noise Figure versus Frequency Across Temperature I<sub>cc</sub>=35mA



Output VSWR versus Frequency Across Temperature







### **PCB** Design Requirements

#### **PCB Surface Finish**

The PCB surface finish used for RFMD's qualification process is Electroless Nickel, immersion Gold. Typical thickness is 3µinch to 8µinch Gold over 180µinch Nickel.

### PCB Land Pattern Recommendation

PCB land patterns are based on IPC-SM-782 standards when possible. The pad pattern shown has been developed and tested for optimized assembly at RFMD; however, it may require some modifications to address company specific assembly processes. The PCB land pattern has been developed to accommodate lead and package tolerances.

### PCB Metal Land Mask Pattern

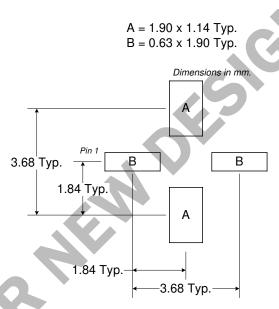
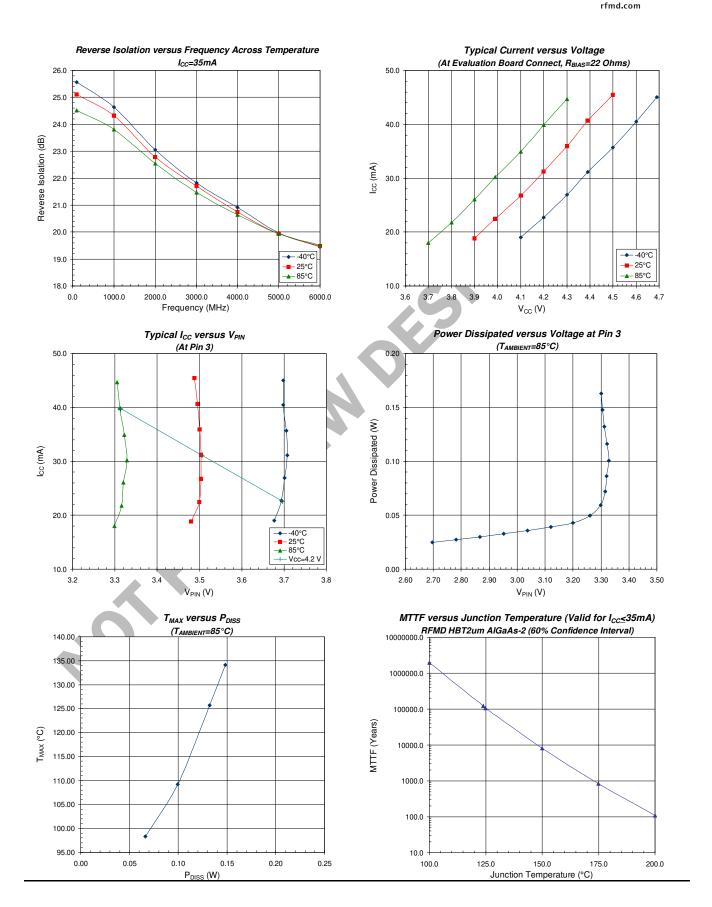


Figure 1. PCB Metal Land Pattern - RF204X (Top View)



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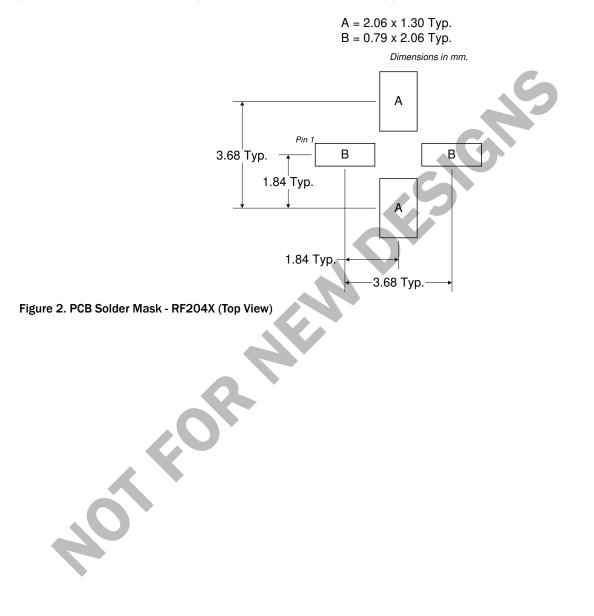
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### PCB Solder Mask Pattern

Liquid Photo-Imageable (LPI) solder mask is recommended. The solder mask footprint will match what is shown for the PCB metal land pattern with a 2mil to 3mil expansion to accommodate solder mask registration clearance around all pads. The center-grounding pad shall also have a solder mask clearance. Expansion of the pads to create solder mask clearance can be provided in the master data or requested from the PCB fabrication supplier.





NEWDESIGNS